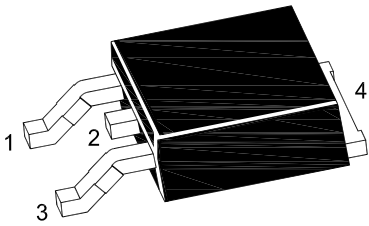
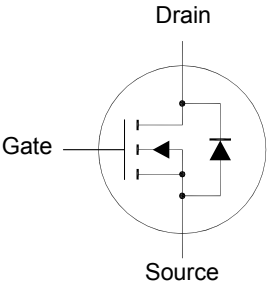


SFTN3172R

N-Channel Enhancement Mode Field Effect Transistor



1. Gate 2. Drain 3. Source 4. Drain
TO-252 Plastic Package

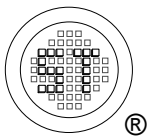


Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current	I_D	36	A
Peak Drain Current	I_{DM}	140	A
Power Dissipation $T_C = 25^{\circ}\text{C}$	P_D	42	W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to + 175	$^{\circ}\text{C}$

Thermal Characteristics

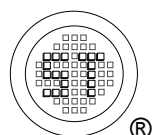
Parameter	Symbol	Max.	Unit
Maximum Thermal Resistance from Junction to Case	$R_{\theta JC}$	3	$^{\circ}\text{C/W}$
Maximum Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	50	$^{\circ}\text{C/W}$

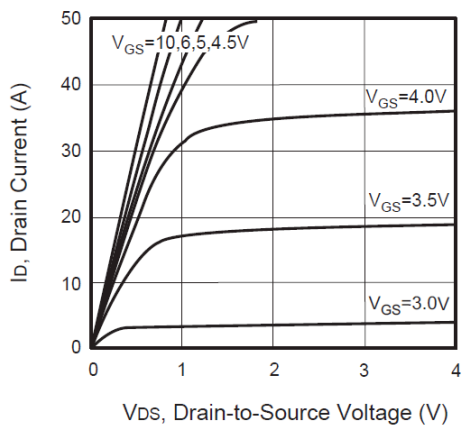


SFTN3172R

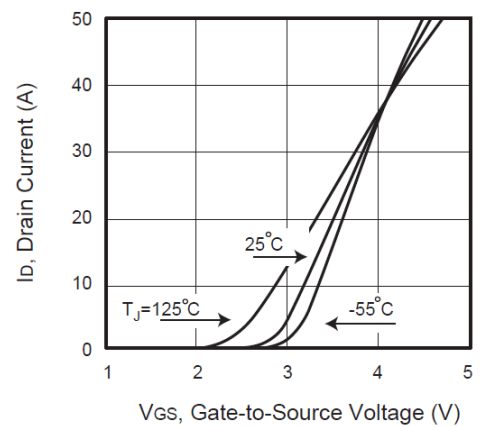
Characteristics at $T_C = 25^\circ\text{C}$ unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage at $I_D = 250\ \mu\text{A}$	BV_{DSS}	30	-	-	V
Drain-Source Leakage Current at $V_{DS} = 30\ \text{V}$	I_{DSS}	-	-	1	μA
Gate Leakage Current at $V_{GS} = \pm 20\ \text{V}$	I_{GSS}	-	-	± 100	nA
Gate-Source Threshold Voltage at $V_{DS} = V_{GS}$, $I_D = 250\ \mu\text{A}$	$V_{GS(th)}$	1	-	3	V
Drain-Source On-State Resistance at $V_{GS} = 10\ \text{V}$, $I_D = 9.5\ \text{A}$ at $V_{GS} = 4.5\ \text{V}$, $I_D = 8\ \text{A}$	$R_{DS(on)}$	- -	- -	20 28	m Ω
Forward Transconductance at $V_{DS} = 5\ \text{V}$, $I_D = 9.5\ \text{A}$	g_{FS}	-	5	-	S
Diode Forward Voltage at $I_S = 2.3\ \text{A}$, $V_{GS} = 0\ \text{V}$	V_{SD}	-	-	1.2	V
Maximun Body-Diode Continuous Current	I_S	-	-	36	A
Input Capacitance at $V_{GS} = 0\ \text{V}$, $V_{DS} = 15\ \text{V}$, $f = 1\ \text{MHz}$	C_{iss}	-	1080	-	pF
Output Capacitance at $V_{GS} = 0\ \text{V}$, $V_{DS} = 15\ \text{V}$, $f = 1\ \text{MHz}$	C_{oss}	-	220	-	pF
Reverse Transfer Capacitance at $V_{GS} = 0\ \text{V}$, $V_{DS} = 15\ \text{V}$, $f = 1\ \text{MHz}$	C_{rss}	-	140	-	pF
Turn-On Delay Time at $I_D = 1\ \text{A}$, $V_{DD} = 15\ \text{V}$, $V_{GS} = 10\ \text{V}$, $R_G = 6\ \Omega$	$t_{d(on)}$	-	-	30	ns
Turn-On Rise Time at $I_D = 1\ \text{A}$, $V_{DD} = 15\ \text{V}$, $V_{GS} = 10\ \text{V}$, $R_G = 6\ \Omega$	t_r	-	-	20	ns
Turn-Off Delay Time at $I_D = 1\ \text{A}$, $V_{DD} = 15\ \text{V}$, $V_{GS} = 10\ \text{V}$, $R_G = 6\ \Omega$	$t_{d(off)}$	-	-	60	ns
Turn-Off Fall Time at $I_D = 1\ \text{A}$, $V_{DD} = 15\ \text{V}$, $V_{GS} = 10\ \text{V}$, $R_G = 6\ \Omega$	t_f	-	-	20	ns

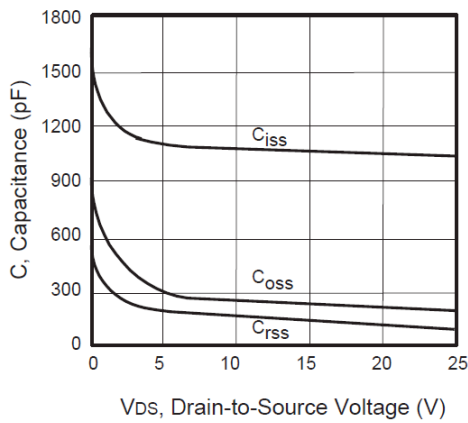




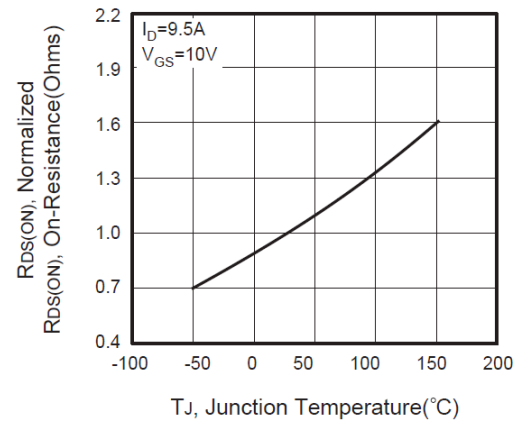
Output Characteristics



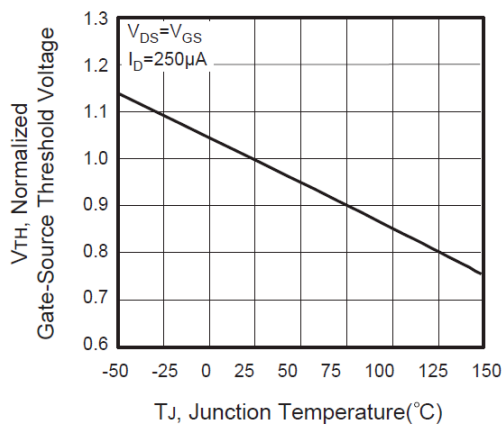
Transfer Characteristics



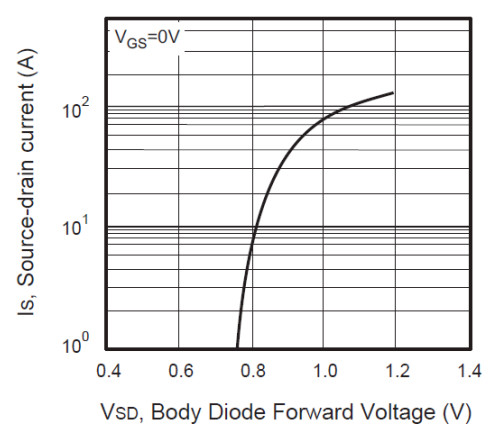
Capacitance



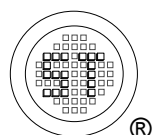
On-Resistance Variation with Temperature



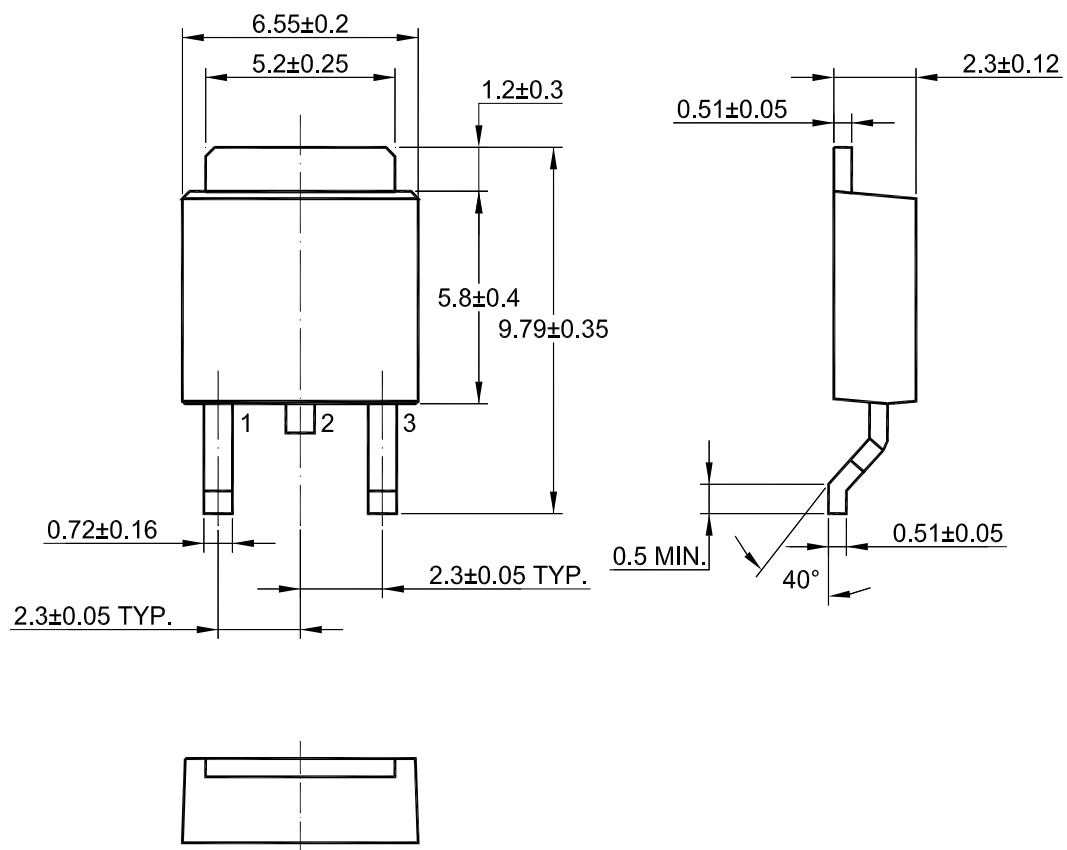
Gate Threshold Variation with Temperature



Body Diode Forward Voltage Variation with Source Current



TO-252 PACKAGE OUTLINE



Dimensions in mm

